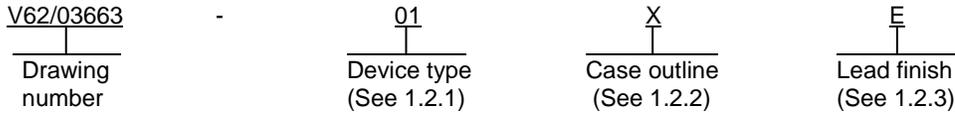


1. SCOPE

1.1 Scope. This drawing documents the general requirements of a high performance octal edge-triggered D-type flip-flop with three-state outputs microcircuit, with an operating temperature range of -40°C to +105°C.

1.2 Vendor Item Drawing Administrative Control Number. The manufacturer's PIN is the item of identification. The vendor item drawing establishes an administrative control number for identifying the item on the engineering documentation:



1.2.1 Device type(s).

<u>Device type</u>	<u>Generic</u>	<u>Circuit function</u>
01	74LV374A-EP	Octal edge-triggered D-type flip-flop with three-state outputs

1.2.2 Case outline. The case outline are as specified herein.

<u>Outline letter</u>	<u>Number of pins</u>	<u>JEDEC PUB 95</u>	<u>Package style</u>
X	20	JEDEC MO-153	Plastic small-outline

1.2.3 Lead finishes. The lead finishes are as specified below or other lead finishes as provided by the device manufacture:

<u>Finish designator</u>	<u>Material</u>
A	Hot solder dip
B	Tin-lead plate
C	Gold plate
D	Palladium
E	Gold flash palladium
Z	Other

1.3 Absolute maximum ratings. 1/

Supply voltage range (V_{CC})	-0.5 V to +7.0 V
Input voltage range (V_I)	-0.5 V to +7.0 V 2/
Voltage range applied to any output in the high-impedance or power-off state (V_O)	-0.5 V to +7.0 V 2/
Output voltage range (V_O)	-0.5 V to $V_{CC} + 0.5 V$ 2/ 3/
Input clamp current (I_{IK}) ($V_I < 0$ or $V_I > V_{CC}$)	± 20 mA
Output clamp current (I_{OK}) ($V_O < 0$ or $V_O > V_{CC}$)	± 50 mA
Continuous output current (I_O) ($V_O = 0$ to V_{CC})	± 35 mA
Continuous current through V_{CC} or GND	± 70 mA
Package thermal impedance (θ_{JA})	83°C/W 4/
Storage temperature range (T_{STG})	-65°C to +150°C

1/ Stresses beyond those listed under "absolute maximum rating" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2/ The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

3/ This value is limited to 5.5 V maximum.

4/ The package thermal impedance is calculated in accordance with JESD 51-7.

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/03663
		REV A	PAGE 2

1.4 Recommended operating conditions. 5/ 6/

Supply voltage range (V_{CC})	2.0 V to 5.5 V
Minimum high level input voltage (V_{IH}):	
$V_{CC} = 2.0$ V	1.5 V
$V_{CC} = 2.3$ V to 2.7 V	$V_{CC} \times 0.7$
$V_{CC} = 3.0$ V to 3.6 V	$V_{CC} \times 0.7$
$V_{CC} = 4.5$ V to 5.5 V	$V_{CC} \times 0.7$
Maximum low level input voltage (V_{IL}):	
$V_{CC} = 2.0$ V	0.5 V
$V_{CC} = 2.3$ V to 2.7 V	$V_{CC} \times 0.3$
$V_{CC} = 3.0$ V to 3.6 V	$V_{CC} \times 0.3$
$V_{CC} = 4.5$ V to 5.5 V	$V_{CC} \times 0.3$
Input voltage range (V_I)	0.0 V to 5.5 V
Output voltage range (V_O):	
High or low state	0.0 V to V_{CC}
Three-state	0.0 V to 5.5 V
Maximum high level output current (I_{OH}):	
$V_{CC} = 2.0$ V	-50 μ A
$V_{CC} = 2.3$ V to 2.7 V	-2 mA
$V_{CC} = 3.0$ V to 3.6 V	-8 mA
$V_{CC} = 4.5$ V to 5.5 V	-16 mA
Maximum low level output current (I_{OL}):	
$V_{CC} = 2.0$ V	50 μ A
$V_{CC} = 2.3$ V to 2.7 V	2 mA
$V_{CC} = 3.0$ V to 3.6 V	8 mA
$V_{CC} = 4.5$ V to 5.5 V	16 mA
Maximum input transition rise or fall rate:	
$V_{CC} = 2.3$ V to 2.7 V	200 ns/V
$V_{CC} = 3.0$ V to 3.6 V	100 ns/V
$V_{CC} = 4.5$ V to 5.5 V	20 ns/V
Operating free-air temperature range (T_A)	-40°C to +105°C

2. APPLICABLE DOCUMENTS

- JEDEC PUB 95 - Registered and Standard Outlines for Semiconductor Devices
- JESD 51-7 - High Effective Thermal Conductivity Test Board for Leaded Surface Mount Packages

(Applications for copies should be addressed to the Electronic Industries Alliance, 2500 Wilson Boulevard, Arlington, VA 22201-3834 or online at <http://www.jedec.org>)

- 5/ Use of this product beyond the manufacturers design rules or stated parameters is done at the user's risk. The manufacturer and/or distributor maintain no responsibility or liability for product used beyond the stated limits.
- 6/ All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/03663
		REV A	PAGE 3

3. REQUIREMENTS

3.1 Marking. Parts shall be permanently and legibly marked with the manufacturer's part number as shown in 6.3 herein and as follows:

- A. Manufacturer's name, CAGE code, or logo
- B. Pin 1 identifier
- C. ESDS identification (optional)

3.2 Unit container. The unit container shall be marked with the manufacturer's part number and with items A and C (if applicable) above.

3.3 Electrical characteristics. The maximum and recommended operating conditions and electrical performance characteristics are as specified in 1.3, 1.4, and table I herein.

3.4 Design, construction, and physical dimension. The design, construction, and physical dimensions are as specified herein.

3.5 Diagrams.

3.5.1 Case outline. The case outline shall be as shown in 1.2.2 and figure 1.

3.5.2 Truth table. The truth table shall be as shown in figure 2.

3.5.3 Logic diagram. The logic diagram shall be as shown in figure 3.

3.5.4 Terminal connections. The terminal connections shall be as shown in figure 4.

3.5.5 Timing waveforms and test circuit. The timing waveforms and test circuit shall be as shown in figure 5.

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/03663
		REV A	PAGE 4

TABLE I. Electrical performance characteristics. 1/

Test	Symbol	Conditions	V _{CC}	Temperature, T _A	Device type	Limits		Unit
						Min	Max	
High level output voltage	V _{OH}	I _{OH} = -50 μA	2.0 V to 5.5 V	25°C, -55°C to 125°C	01	V _{CC} - 0.1		V
		I _{OH} = -2 mA	2.3 V	25°C, -55°C to 125°C		2.0		
		I _{OH} = -8 mA	3.0 V	25°C, -55°C to 125°C		2.48		
		I _{OH} = -16 mA	4.5 V	25°C, -55°C to 125°C		3.8		
Low level output voltage	V _{OH}	I _{OL} = 50 μA	2.0 V to 5.5 V	25°C, -55°C to 125°C	01		0.1	V
		I _{OL} = 2 mA	2.3 V	25°C, -55°C to 125°C			0.4	
		I _{OL} = 8 mA	3.0 V	25°C, -55°C to 125°C			0.44	
		I _{OL} = 16 mA	4.5 V	25°C, -55°C to 125°C			0.55	
Input current	I _I	V _I = 5.5 V or GND	0.0 V to 5.5 V	25°C, -55°C to 125°C	01		±1.0	μA
3-state output current	I _{OZ}	V _O = V _{CC} or GND	5.5 V	25°C, -55°C to 125°C	01		±5.0	μA
Quiescent supply current	I _{CC}	V _I = V _{CC} or GND I _O = 0 A	5.5 V	25°C, -55°C to 125°C	01		20.0	μA
Input/output power-off leakage current	I _{off}	V _I or V _O = 0.0 V to 5.5 V	0.0 V	25°C, -55°C to 125°C	01		5.0	μA
Input capacitance	C _I	V _I = V _{CC} or GND	3.3 V	25°C, -55°C to 125°C	01	2.9 TYP		pF
Power dissipation capacitance	C _{pd}	C _L = 50 pF f = 10 MHz	3.3 V	25°C	01	21.1 TYP		pF
			5.0 V			22.8 TYP		

See footnote at end of table.

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/03663
		REV A	PAGE 5

TABLE I. Electrical performance characteristics - Continued. 1/

Test	Symbol	Conditions	V _{CC}	Temperature, T _A	Device type	Limits		Unit
						Min	Max	
Quiet output, maximum dynamic V _{OL}	V _{OL(P)} <u>2/</u>	C _L = 50 pF	3.3 V	25°C	01		0.8	V
Quiet output, minimum dynamic V _{OL}	V _{OL(V)} <u>2/</u>		3.3 V	25°C			-0.8	V
Quiet output, minimum dynamic V _{OH}	V _{OH(V)} <u>2/</u>		3.3 V	25°C		2.9 TYP		V
High level dynamic input voltage	V _{IH(D)} <u>2/</u>		3.3 V	25°C		2.31		V
Low level dynamic input voltage	V _{IL(D)} <u>2/</u>		3.3 V	25°C			0.99	V
Maximum operating frequency	f _{max}	C _L = 50 pF See figure 5	3.0 V and 3.6 V	25°C	01	55		MHz
				-55°C to 125°C		50		
			4.5 V and 5.5 V	25°C		85		
				-55°C to 125°C		75		
Propagation delay time, CLK to Q	t _{pd}	C _L = 50 pF See figure 5	3.0 V and 3.6 V	25°C	01		16.2	ns
				-55°C to 125°C		1.0	18.5	
			4.5 V and 5.5 V	25°C			10.1	
				-55°C to 125°C		1.0	13.5	
Propagation delay time, OE to Q	t _{en}	C _L = 50 pF See figure 5	3.0 V and 3.6 V	25°C	01		14.5	ns
				-55°C to 125°C		1.0	17.5	
			4.5 V and 5.5 V	25°C			9.6	
				-55°C to 125°C		1.0	13.0	
Propagation delay time, OE to Q	t _{dis}	C _L = 50 pF See figure 5	3.0 V and 3.6 V	25°C	01		14.0	ns
				-55°C to 125°C		1.0	16.0	
			4.5 V and 5.5 V	25°C			8.8	
				-55°C to 125°C		1.0	10.0	

See footnote at end of table.

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/03663
		REV A	PAGE 6

TABLE I. Electrical performance characteristics - Continued. 1/

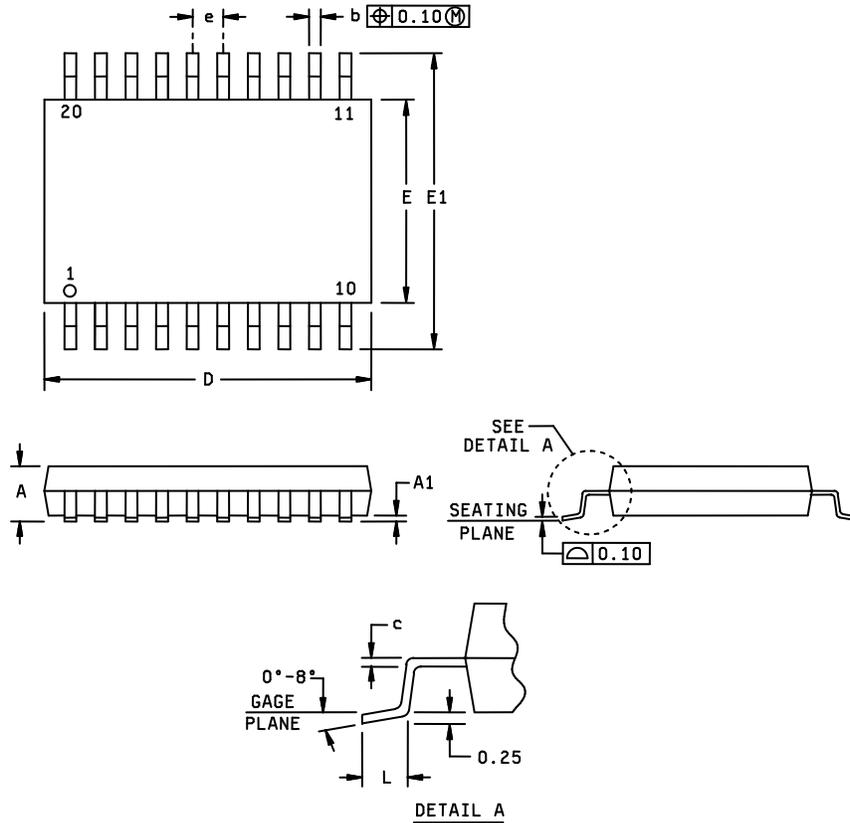
Test	Symbol	Conditions	V _{CC}	Temperature, T _A	Device type	Limits		Unit
						Min	Max	
Output skew	t _{sk(o)}	C _L = 50 pF See figure 5	3.0 V and 3.6 V	25°C	01		1.5	ns
			4.5 V and 5.5 V	25°C			1.0	
Pulse duration, CLK high or low	t _w	See figure 5	3.0 V and 3.6 V	25°C	01	5.0		ns
				-55°C to 125°C		5.5		
			4.5 V and 5.5 V	25°C		5.0		
				-55°C to 125°C		5.0		
Setup time, data before CLK↑	t _w	See figure 5	3.0 V and 3.6 V	25°C	01	4.5		ns
				-55°C to 125°C		4.5		
			4.5 V and 5.5 V	25°C		3.0		
				-55°C to 125°C		3.0		
Hold time, data after CLK↑	t _w	See figure 5	3.0 V and 3.6 V	25°C	01	2.0		ns
				-55°C to 125°C		2.0		
			4.5 V and 5.5 V	25°C		2.0		
				-55°C to 125°C		2.0		

1/ Testing and other quality control techniques are used to the extent deemed necessary to assure product performance over the specified temperature range. Product may not necessarily be tested across the full temperature range and all parameters may not necessarily be tested. In the absence of specific parametric testing, product performance is assured by characterization and/or design.

2/ Characteristics are for surface-mount packages only.

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/03663
		REV A	PAGE 7

Case X



Dimensions									
Symbol	Millimeters		Inches		Symbol	Millimeters		Inches	
	Min	Max	Min	Max		Min	Max	Min	Max
A	---	1.20	---	.047	E	4.30	4.50	.169	.177
A1	0.05	0.15	.002	.006	E1	6.20	6.60	.244	.260
b	0.19	0.30	.007	.012	e	0.65 NOM		.026 NOM	
c	0.15 NOM		.006 NOM		L	0.50	0.75	.020	.030
D	6.40	6.60	.252	.260					

NOTES:

1. This drawing is subject to change without notice.
2. Body dimensions do not include mold flash or protrusion not to exceed 0.15 mm.
3. Falls within JEDEC MO-153.
4. All linear dimensions are shown in millimeters (inches). Inches equivalents are given for general information only.

FIGURE 1. Case outlines.

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/03663
		REV A	PAGE 8

(each flip-flop)

Inputs			Output Q
\overline{OE}	CLK	D	
L	↑	H	H
L	↑	L	L
L	L	X	Q_0
H	X	X	Z

X = Immaterial
 Z = High impedance state
 ↑ = Rising edge of CLK.

FIGURE 2. Truth table.

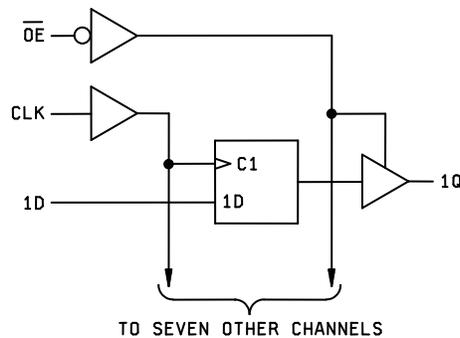
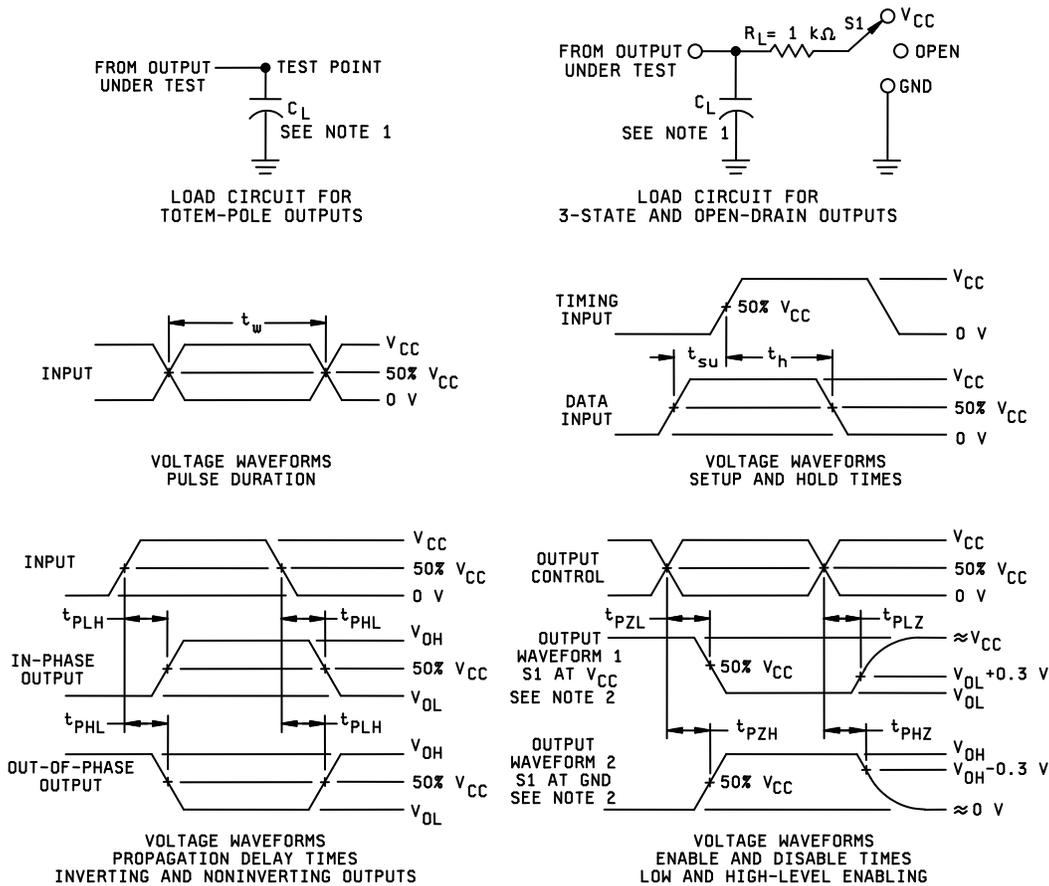


FIGURE 3. Logic diagram.

Device type 01			
Case outlines: X and Y			
Terminal number	Terminal symbol	Terminal number	Terminal symbol
1	\overline{OE}	11	CLK
2	1Q	12	5Q
3	1D	13	5D
4	2D	14	6D
5	2Q	15	6Q
6	3Q	16	7Q
7	3D	17	7D
8	4D	18	8D
9	4Q	19	8Q
10	GND	20	V_{CC}

FIGURE 4. Terminal connections.

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/03663
		REV A	PAGE 9



Notes:

1. C_L includes probe and jig capacitance.
2. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
3. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1\text{ MHz}$, $Z_O = 50\Omega$, $t_r \leq 3\text{ ns}$, $t_f \leq 3\text{ ns}$.
4. The outputs are measured one at a time with one input transition per measurement.
5. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
6. t_{PZL} and t_{PZH} are the same as t_{en} .
7. t_{PHL} and t_{PLH} are the same as t_{pd} .
8. For 3-state and Open Drain outputs tests:

t_{PLH}/t_{PHL}	S1 = Open
t_{PLZ}/t_{PZL}	S1 = V_{CC}
t_{PHZ}/t_{PZH}	S1 = GND
Open Drain	S1 = V_{CC}

FIGURE 5. Timing waveforms and test circuit.

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/03663
		REV A	PAGE 10

4. QUALITY ASSURANCE PROVISIONS

4.1 Product assurance requirements. The manufacturer is responsible for performing all inspection and test requirements as indicated in their internal documentation. Such procedures should include proper handling of electrostatic sensitive devices, classification, packaging, and labeling of moisture sensitive devices, as applicable.

5. PREPARATION FOR DELIVERY

5.1 Packaging. Preservation, packaging, labeling, and marking shall be in accordance with the manufacturer's standard commercial practices for electrostatic discharge sensitive devices.

6. NOTES

6.1 ESDS. Devices are electrostatic discharge sensitive and are classified as ESDS class 1 minimum.

6.2 Configuration control. The data contained herein is based on the salient characteristics of the device manufacturer's data book. The device manufacturer reserves the right to make changes without notice. This drawing will be modified as changes are provided.

6.3 Suggested source(s) of supply. Identification of the suggested source(s) of supply herein is not to be construed as a guarantee of present or continued availability as a source of supply for the item.

Vendor item drawing administrative control number <u>1/</u>	Device manufacturer CAGE code	Vendor part number	Top-Side Marking
V62/03663-01XE	01295	SN74LV374ATPWREP	LV374AEP

1/ The vendor item drawing establishes an administrative control number for identifying the item on the engineering documentation.

CAGE code

01295

Source of supply

Texas Instruments, Inc.
 Semiconductor Group
 8505 Forest lane
 P.O. Box 660199
 Dallas, TX 75243
 Point of contact: U.S. Highway 75 South
 P.O. Box 84, M/S 853
 Sherman, TX 75090-9493

DEFENSE SUPPLY CENTER, COLUMBUS COLUMBUS, OHIO	SIZE A	CODE IDENT NO. 16236	DWG NO. V62/03663
		REV A	PAGE 11